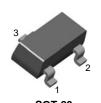
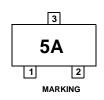
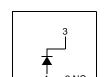


# **MMBD6050 Small Signal Diode**

April 2007







**Connection Diagram** 

# Absolute Maximum Ratings \* T<sub>A</sub> = 25°C unless otherwise noted

Symbol	Parameter	Value	Units	
V <sub>RRM</sub>	Maximum Repetitive Reverse Voltage	70	V	
I <sub>F(AV)</sub>	Average Rectified Forward Current	200	mA	
I <sub>FSM</sub>	Non-repetitive Peak Forward Surge Current Pulse Width = 1.0 second Pulse Width = 1.0 microsecond	1.0 2.0	A A	
T <sub>STG</sub>	Storage Temperature Range	-55 to +150	°C	
T <sub>J</sub>	Operating Junction Temperature	-55 to +150	°C	

<sup>\*</sup> These ratings are limiting values above which the serviceability of the diode may be impaired.

- These ratings are based on a maximum junction temperature of 150 degrees C.
   These are steady limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.

### **Thermal Characteristics**

Symbol	Parameter	Value	Units
$P_{D}$	Power Dissipation	350	mW
$R_{ heta JA}$	Thermal Resistance, Junction to Ambient	357	°C/W

# Electrical Characteristics T<sub>A</sub>=25°C unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Max.	Units
V <sub>R</sub>	Breakdown Voltage	I <sub>R</sub> = 100μA	70		V
V <sub>F</sub>	Forward Voltage	I <sub>F</sub> = 1mA I <sub>F</sub> = 100mA	0.55 0.85	0.7 1.1	V
I <sub>R</sub>	Reverse Leakage	V <sub>R</sub> =50V		100	nA
C <sub>T</sub>	Total Capacitance	V <sub>R</sub> = 0V, f = 1.0MHz		2.5	pF
t <sub>rr</sub>	Reverse Recovery Time	$I_F = I_R = 10 \text{mA},$ $I_{RR} = 1.0 \text{mA}, R_L = 100 \Omega$		4.0	ns

# **Typical Performance Characteristics**

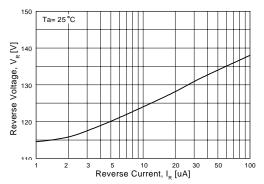


Figure 1. Reverse Voltage vs Reverse Current BV - 1.0 to 100uA

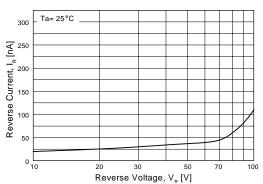


Figure 2. Reverse Current vs Reverse Voltage IR - 10 to 100 V

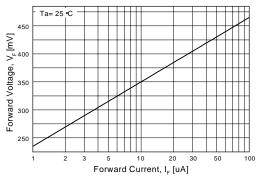


Figure 3. Forward Voltage vs Forward Current VF - 1.0 to 100 uA

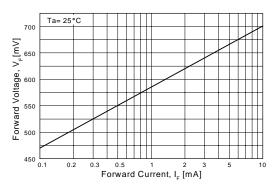


Figure 4. Forward Voltage vs Forward Current VF - 0.1 to 10 mA

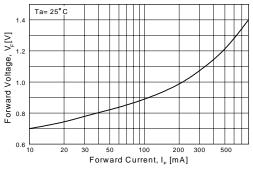


Figure 5. Forward Voltage vs Forward Current VF - 10 - 800 mA

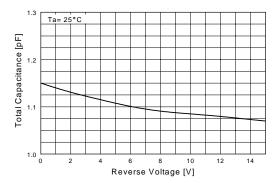


Figure 6. Total Capacitance vs Reverse Voltage

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# **Typical Performance Characteristics** (Continued)

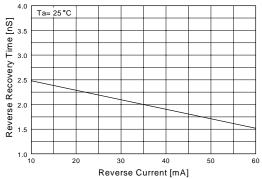


Figure 7. Reverse Recovery Time vs Reverse Current TRR - IR 10 mA vs 60 mA

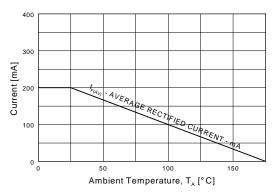
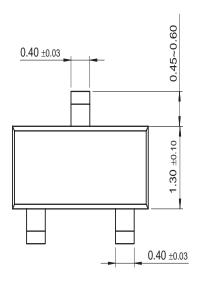
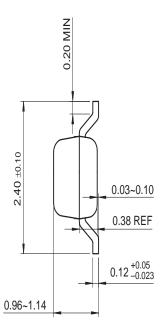


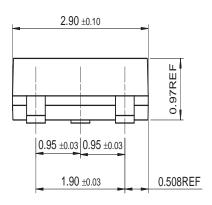
Figure 8. Average Rectified Current ( $I_{F(AV)}$ ) versus Ambient Temperature ( $T_A$ )

# **Mechanical Dimensions**

# SOT-23











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